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Execution Date
Month Day Year
05/24/2002

Name (line 1) CHIN, Hung

Name (line 2)

Second Party

Execution Date
Month Day Year
05/24/2002

Name (line 1) HU, Ching-Yi

Name (line 2)

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Name (line 1) ORIENT SEMICONDUCTOR ELECTRONICS LIMITED

Name (line 2)

Address (line 1) No.9, Chung-San St.,

Address (line 2) N.E.P.Z.

Address (line 3) Kaohsiung

TAIWAN

City

State/Country

Zip Code

Domestic Representative Name and Address

Enter for the first Receiving Party only.

Name

Address (line 1)

Address (line 2)

Address (line 3)

Address (line 4)

06/07/2002 DBYRNE 00000038 10159030

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PATENT
REEL: 012955 FRAME: 0061

Correspondent Name and Address

Area Code and Telephone Number

Name CHIN, Hung

Address (line 1) PO Box 82-144

Address (line 2) Taipei, TAIWAN

Address (line 3)

Address (line 4)

Pages

Enter the total number of pages of the attached conveyance document including any attachments.

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Patent Application Number(s)

Patent Number(s)

If this document is being filed together with a new Patent Application, enter the date the patent application was signed by the first named executing inventor.

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Patent Cooperation Treaty (PCT)

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Number of Properties

Enter the total number of properties involved.

1

Fee Amount

Fee Amount for Properties Listed (37 CFR 3.41): \$

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Authorization to charge additional fees:

Yes ☐

No ☐

Statement and Signature

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Charges to deposit account are authorized, as indicated herein.

1. CHIN, Hung 2. HU, Ching-Yi

1. CHIN Hung
2. HU, Ching-Yi

May 24, 2002

May 24, 2002

Name of Person Signing

Signature

Date

ASSIGNMENT

U.S.A.

(1) CHIN, Hung (2) HU, Ching-Yi (3) _____

(Hereinafter referred to as the assignors), residing at

(1) No. 281, Yu-Hsing St., Kuan-Sheng Li, E. Dis. Kaohsiung City, Taiwan

(2) No. 16, Lane 99, Shou-Min Rd., Nan-Tsu Dis., Kaohsiung City, Taiwan

(3) _____

Witnesseth: WHEREAS, the said ASSIGNOR/S has/have invented/owned certain

new and useful Invention entitled METHOD OF AFFIXING A HEAT SINK TO A SUBSTRATE AND
PACKAGING THEREOF

with _____ serial No. _____ as filed on _____

and set forth in an application for Letters Patent of _____ Invention

executed simultaneously herewith and WHEREAS.

(1) ORIENT SEMICONDUCTOR ELECTRONICS LIMITED

(2) _____

(hereinafter referred to as the ASSIGNEE/S),

(1) ORIENT SEMICONDUCTOR ELECTRONICS LIMITED

(2) _____

(3)

 , having his/their residence/s at

(1) No. 9, Chung-San St., N.E.P.Z., Kaohsiung, Taiwan

(2)

(3)

are desirous of acquiring the entire right, title and interest in and to said inventions

and said application for Letters Patent of _____

and in and to any Letters Patent or Patents, _____

or foreign, to be obtained therefore and thereon: NOW THEREFORE TO ALL

WHOM IT MAY CONCERN: be it known that in consideration of the payment by

ASSIGNEE/S to ASSIGNOR/S of the sum corresponding to One Dollar (\$1.00), the

receipt of which is hereby acknowledged, and for other good and valuable

consideration, ASSIGNOR/S hereby sell/s and transfer/s to ASSIGNEE/S the full

and exclusive right, titled and interest to said invention and all Letters Patent of

_____ to be obtained therefore on said application or any

continuation, division, renewal, substitute or reissue thereof for the full term or terms

for which the same may be granted. ASSIGNOR/S hereby covenant/s that no

assignment, sale, agreement of encumbrance has/have been or will be made or

entered into which would conflict with this assignment and sale:

ASSIGNOR/S further covenant/s that ASSIGNEE/S will, upon its/their request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent as may be known and accessible to


ASSIGNOR/S and will testify as to the same in any interference or litigation related thereto and will promptly execute and deliver to ASSIGNEE/S or its/their legal representative any and all papers, instruments or affidavits required to apply for obtain maintain and enforce said application, said invention and said Letters Patent which may be necessary or desirable to carry out the purposes hereof.

IN WITNESS WHEREOF, have hereunto set hand and seal this

24th day of May, 2001 ²

SIGNATURE:

ASSIGNOR/S: (1) CHIN, Hung (2) HU, Ching-Yi
CHIN, Hung HU, Ching-Yi

ASSIGNEE/S: (1)  Mary S. DuH
Mary S. DUH (President)
For: ORIENT SEMICONDUCTOR ELECTRONICS LIMITED